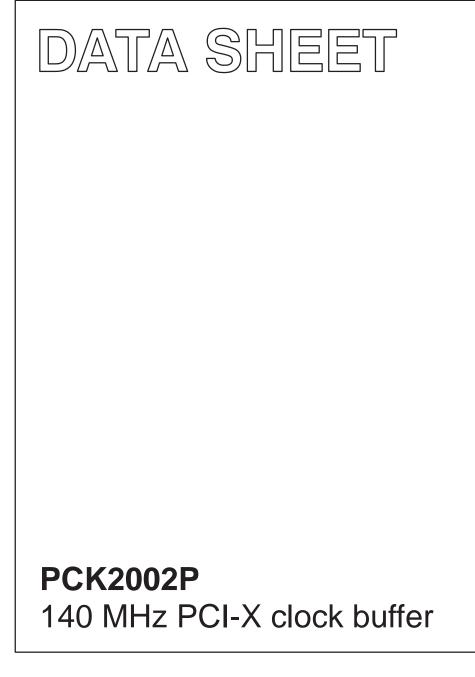
INTEGRATED CIRCUITS



Product data

2001 May 09

File under Integrated Circuits ICL03





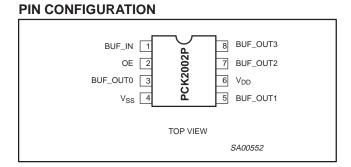
PCK2002P

FEATURES

- General purpose and PCI-X 1:4 clock buffer
- 8-pin TSSOP package
- See PCK2001 for 48-pin 1:18 buffer part
- See PCK2001M for 28-pin 1:10 buffer part
- See PCK2001R for 16-pin 1:6 buffer part
- Operating frequency: 0 140 MHz
- Part-to-part skew < 500 ps
- Low output skew: <200 ps
- 3.3 V operation
- ESD classification testing is done to JEDEC Standard JESD22. Protection exceeds 2000 V to HBM per method A114.

DESCRIPTION

The PCK2002PL is a 1–4 fanout buffer used as a high-performance, low skew, general purpose and PCI-X clock buffer. It distributes one input clock (BUF_IN) signal to four output clocks (BUF_OUT_n).



PIN DESCRIPTION

| PIN NUMBER | I/O TYPE | SYMBOL | FUNCTION |
|---------------|-------------|------------------|------------------------|
| 1 | Input | BUF_IN | Buffered clock input |
| 3, 5, 7, 8 | Output | BUF_OUT (0-3) | Buffered clock outputs |
| 6 | Input | V _{DD} | 3.3 V supply |
| 2 | Input | OE | Output Enable |
| 4 | Input | V _{SS} | Ground |

QUICK REFERENCE DATA

| SYMBOL | PARAMETER | CONDITIONS | TYPICAL | UNIT |
|--------------------------------------|---|---|------------|------|
| t _{PLH} t _{PHL} | Propagation delay BUF_IN to BUF_OUT _n | $V_{CC} = 3.3 \text{ V}, C_L = 25 \text{ pF}$ | 2.9 2.8 | ns |
| t _r | Rise time | V_{CC} = 3.3 V, C_L = 25 pF, 0.2V_{DD} to 0.6V_{DD} | 800 | ps |
| t _f | Fall time | V_{CC} = 3.3 V, C_L = 25 pF, 0.6V_{DD} to 0.2V_{DD} | 600 | ps |
| I _{CC} | Total supply current | V _{CC} = 3.6 V | 50 | μΑ |

ORDERING INFORMATION

| PACKAGES | TEMPERATURE RANGE | ORDER CODE | DRAWING NUMBER |
|---------------------|-------------------|------------|----------------|
| 8-Pin Plastic TSSOP | −40 to +85 °C | PCK2002PDP | SOT505-1 |
| 8-Pin Plastic SO | −40 to +85 °C | PCK2002PD | SOT96-1 |

PCK2002P

FUNCTION TABLE

| OE | BUF_IN | BUF_OUTn |
|----|--------|----------|
| L | Х | L |
| Н | L | L |
| Н | Н | Н |

ABSOLUTE MAXIMUM RATINGS^{1, 2}

In accordance with the Absolute Maximum Rating System (IEC 134). Voltages are referenced to V_{SS} ($V_{SS} = 0$ V).

| SYMBOL | DADAMETED | CONDITION | LI | LINUT | |
|------------------|---|--|------|-----------------------|------|
| STMBOL | PARAMETER | CONDITION | MIN | MAX | UNIT |
| V _{DD} | DC 3.3 V supply voltage | | -0.5 | +4.3 | V |
| I _{IK} | DC input diode current | V ₁ < 0 | — | -50 | mA |
| VI | DC input voltage | Note 2 | -0.5 | V _{DD} + 0.5 | V |
| I _{OK} | DC output diode current | $V_{O} > V_{DD}$ or $V_{O} < 0$ | — | ±50 | mA |
| Vo | DC output voltage | Note 2 | -0.5 | V _{DD} + 0.5 | V |
| Ι _Ο | DC output source or sink current | $V_O \ge 0$ to V_{DD} | — | ±50 | mA |
| T _{stg} | Storage temperature range | | -65 | +150 | °C |
| P _{tot} | Power dissipation per package plastic medium-shrink SO (SSOP) | For temperature range: 0 to +70 °C above +55 °C derate linearly with 11.3 mW/K | — | 850 | mW |

NOTES:

 Stresses beyond those listed may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

2. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

RECOMMENDED OPERATING CONDITIONS

| SYMBOL | PARAMETER | CONDITIONS | LIM | UNIT | |
|------------------|---|------------|-----|-----------------|------|
| STWBUL | PARAMETER | CONDITIONS | MIN | MAX | UNIT |
| V _{DD} | DC 3.3V supply voltage | | 3.0 | 3.6 | V |
| CL | Capacitive load | | 20 | 30 | pF |
| VI | DC input voltage range | | 0 | V _{DD} | V |
| Vo | DC output voltage range | | 0 | V _{DD} | V |
| T _{amb} | Operating ambient temperature range in free air | | -40 | +85 | °C |

PCK2002P

DC CHARACTERISTICS

| | | TEST CONDITIONS | | | LIMITS T _{amb} = -40 to +85 °C | | UNIT |
|-----------------|--------------------------|---------------------|---------------------------|--------------------|--|-----------------------|------|
| SYMBOL | PARAMETER | | | | | | |
| | | V _{DD} (V) | V) OTHER | | MIN | MAX | |
| V _{IH} | HIGH level input voltage | 3.0 to 3.6 | — | _ | 2.0 | V _{DD} + 0.3 | V |
| V _{IL} | LOW level input voltage | 3.0 to 3.6 | — | — | V _{SS} – 0.3 | 0.8 | V |
| | | 3.0 to 3.6 | I _{OH} = -1 mA | — | V _{DD} – 0.2 | — | V |
| V _{OH} | H Output HIGH voltage | 3.0 | I _{OH} = -24 mA | — | 2.0 | _ | V |
| | | 3.0 | I _{OH} = -12 mA | — | 2.4 | — | V |
| | | 3.0 to 3.6 | I _{OL} = 1 mA | _ | _ | 0.2 | V |
| V _{OL} | Output LOW voltage | 3.0 | I _{OL} = 24 mA | _ | _ | 0.8 | V |
| | | 3.0 | I _{OL} = 12 mA | — | — | 0.55 | V |
| | | 3.0 | V _{OUT} = 1 V | _ | -50 | _ | mA |
| ЮН | Output HIGH current | 3.3 | V _{OUT} = 1.65 V | — | _ | -150 | mA |
| | | 3.0 | V _{OUT} = 2.0 V | _ | 60 | _ | mA |
| IOL | Output LOW current | 3.3 | V _{OUT} = 1.65 V | — | _ | 150 | mA |
| ±II | Input leakage current | 3.6 | $V_{I} = V_{DD}$ or GND | — | _ | ±5 | μΑ |
| I _{CC} | Quiescent supply current | 3.6 | $V_{I} = V_{DD}$ or GND | l _O = 0 | _ | 100 | μΑ |

PCK2002P

AC CHARACTERISTICS

| SYMBOL | PARAMETER | TEST CONDITIONS | | LIMITS T _{amb} = -40 to +85 °C | | | UNIT |
|--------------------|-----------------------------|-----------------|-------|--|------------------|-----|------|
| | | | NOTES | MIN | TYP ⁶ | MAX | |
| T _H | CLK HIGH time | 66 MHz | 2 | 6.0 | — | — | ns |
| TL | CLK LOW time | | 3 | 6.0 | — | — | ns |
| T _H | CLK HIGH time | 140 MHz | 2 | 2.9 | — | — | ns |
| TL | CLK LOW time | 140 MHZ | 3 | 3.0 | — | — | ns |
| T _R | Output rise slew rate | | 4 | 1.4 | 1.7 | 4.0 | V/ns |
| T _F | Output fall slew rate | | 4 | 1.5 | 2.2 | 4.0 | V/ns |
| T _{PLH} | Buffer LH propagation delay | | 5 | 1.8 | 2.9 | 3.4 | ns |
| T _{PHL} | Buffer HL propagation delay | | 5 | 1.8 | 2.8 | 3.4 | ns |
| Т _{SKW} | Bus CLK skew | | 1 | _ | _ | 200 | ps |
| T _{DDSKW} | Device to device skew | | 1 | _ | _ | 500 | ps |

NOTES:

1. CLK skew is only valid for equal loading of all outputs.

2. T_H is measured at 0.5 V_{DD} as shown in Figure 2. 3. T_L is measured at 0.35 V_{DD} as shown in Figure 2. 4. T_R and T_F are measured as a transition through the threshold region 0.2 V_{DD} to 0.6 V_{DD} and 0.6 V_{DD} to 0.2 V_{DD} . 5. Input edge rate for these tests must be faster than 1 V/ns.

6. All typical values are at $V_{CC} = 3.3$ V and $T_{amb} = 25$ °C.

AC WAVEFORMS

 $V_M = 50\% V_{DD}$

 $C_{L}^{...} = 25 \text{ pF}$

 $\bar{V_{OL}}$ and \bar{V}_{OH} are the typical output voltage drop that occur with the output load.

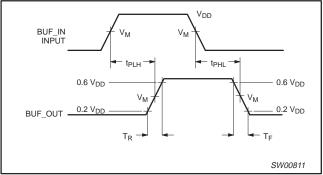


Figure 1. Load circuitry for switching times.

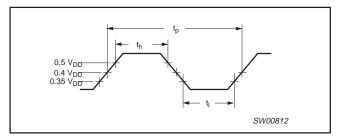


Figure 2. Buffer Output clock

TEST CIRCUIT

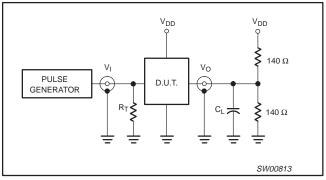
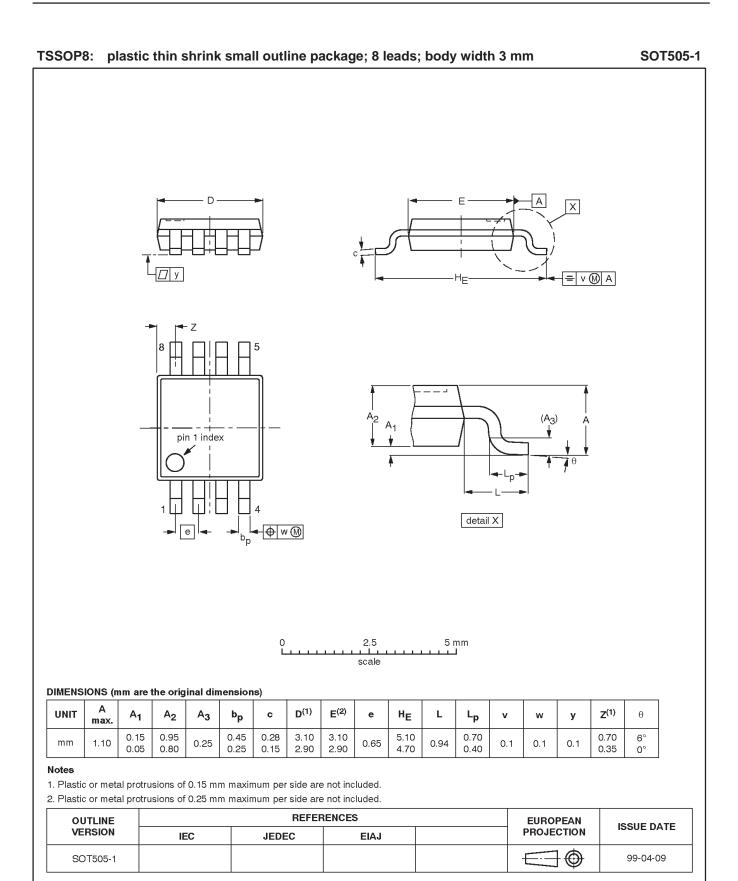


Figure 3. Load circuitry for switching times

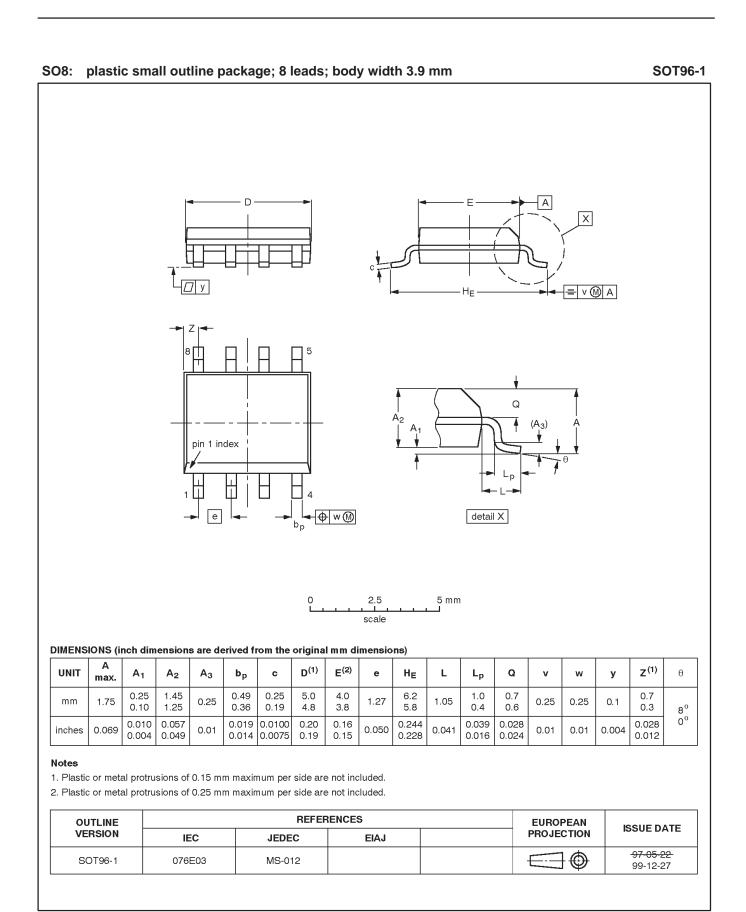
PCK2002P

Product data



PCK2002P

Product data



PCK2002P

Data sheet status

| Data sheet status ^[1] | Product status ^[2] | Definitions |
|----------------------------------|----------------------------------|--|
| Objective data | Development | This data sheet contains data from the objective specification for product development. Philips Semiconductors reserves the right to change the specification in any manner without notice. |
| Preliminary data | Qualification | This data sheet contains data from the preliminary specification. Supplementary data will be published at a later date. Philips Semiconductors reserves the right to change the specification without notice, in order to improve the design and supply the best possible product. |
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[1] Please consult the most recently issued datasheet before initiating or completing a design.

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Short-form specification — The data in a short-form specification is extracted from a full data sheet with the same type number and title. For detailed information see the relevant data sheet or data handbook.

Limiting values definition — Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

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